

#### **MOSFET**

## OptiMOS™ 6 Power-Transistor, 80 V

#### **Features**

Part number

ISC018N08NM6SC

- Dual-side cooled package with lowest Junction-top thermal resistance
- Optimized for high performance SMPS
- N-channel, normal level
- Very low on-resistance R<sub>DS(on)</sub>
   Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC6129-2-21

### **Product validation**

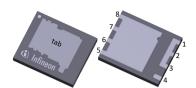
Fully qualified according to JEDEC for Industrial Applications

Table 1 Key performance parameters

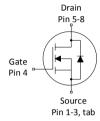
-	
Value	Unit
80	V
1.8	mΩ
230	A
126	nC
63	nC
54	nC
	80 1.8 230 126 63

**Package** 

PG-WSON-8



PG-WSON-8





	RoHS
Marking	Related links

018N08SC

### Public

# OptiMOS™ 6 Power-Transistor, 80 V ISC018N08NM6SC



## Table of contents

Description	1
Maximum ratings	3
Thermal characteristics	4
Electrical characteristics	5
Electrical characteristics diagrams	7
Package outlines	11
Revision history	14
Trademarks	15
Disclaimer	15

## OptiMOS™ 6 Power-Transistor, 80 V ISC018N08NM6SC



## 1 Maximum ratings

at  $T_{\Delta}$ =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davamatav	Values				1154	Nieko / Teek een dikien	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test condition	
				230		$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C	
2	<b>,</b>			163		$V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C	
Continuous drain current 1)	I <sub>D</sub>	-	-	138 A $V_{GS} = 8 \text{ V}, T_{C} = 100 ^{\circ}\text{C}$		$V_{\rm GS}$ =8 V, $T_{\rm C}$ =100 °C	
				27		$V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm THJA}$ =50 °C/W <sup>2)</sup>	
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>			920	A	<i>T<sub>c</sub></i> =25 °C	
Avalanche current, single pulse <sup>4)</sup>	I <sub>AS</sub>			50		1 <sub>C</sub> -25 C	
Avalanche energy, single pulse	$E_{AS}$	-	-	851	mJ	$I_{\rm D}$ =24 A, $R_{\rm GS}$ =25 $\Omega$	
Gate source voltage	$V_{\rm GS}$	-20	-	20	V	-	
Dawar dissipation	0	-		217	W	<i>T</i> <sub>C</sub> =25 °C	
Power dissipation	$P_{\text{tot}}$		-	3.0	VV	$T_A$ =25 °C, $R_{thJA}$ =50 °C/W <sup>2)</sup>	
Operating and storage temperature	$T_{\rm j}, T_{\rm stg}$	-55	-	175	°C	-	

<sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^2$  (one layer, 70  $\mu$ m thick) copper area for drain connection. PCB is vertical in still air.

<sup>3)</sup> See Diagram 3 for more detailed information

<sup>4)</sup> See Diagram 13 for more detailed information

# OptiMOS™ 6 Power-Transistor, 80 V ISC018N08NM6SC



## 2 Thermal characteristics

Table 3 Thermal characteristics

Darameter	Symbol		Values		Linit	Note / Test condition
Parameter	Symbol	Min.	Тур.	Max.		
Thermal resistance, junction - case, bottom	$R_{thJC}$		0.35	0.69		
Thermal resistance, junction - case, top	$R_{thJC}$	-	0.36	0.72	°C/W	-
Thermal resistance, junction - ambient, 6 cm <sup>2</sup> cooling area <sup>5)</sup>	$R_{thJA}$		-	50		

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^2$  (one layer, 70  $\mu$ m thick) copper area for drain connection. PCB is vertical in still air.

## OptiMOS™ 6 Power-Transistor, 80 V ISC018N08NM6SC



## 3 Electrical characteristics

at  $T_i$ =25 °C, unless otherwise specified

Table 4 Static characteristics

Davamatav	Cymbal		Values			Nieto / Test condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test condition	
Drain-source breakdown voltage	$V_{(BR)DSS}$	80	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	2.4	3.0	3.5	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 114  \mu \text{A}$	
Zero gate voltage drain current	,	0.1		1		$V_{\rm DS}$ =64 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C	
	I <sub>DSS</sub>	-	10	100	μΑ	$V_{\rm DS}$ =64 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =125 °C <sup>6)</sup>	
Gate-source leakage current	$I_{GSS}$	-	10	100	nA	$V_{GS}$ =±20 V, $V_{DS}$ =0 V	
Drain-source on-state resistance	D	-	1.5	1.8	mΩ	V <sub>GS</sub> =10 V, I <sub>D</sub> =50 A	
Diain-source on-state resistance	$R_{\mathrm{DS(on)}}$		1.8	2.3	11122	$V_{\rm GS}$ =8 V, $I_{\rm D}$ =25 A	
Gate resistance	$R_{G}$	0.5	0.77	1.0	Ω	-	
Transconductance <sup>6)</sup>	$g_{fs}$	55	110	-	S	$ V_{\rm DS}  \ge 2 I_{\rm D} R_{\rm DS(on)max}, I_{\rm D} = 50 \text{ A}$	

<sup>6)</sup> Defined by design. Not subject to production test.

Table 5 Dynamic characteristics

Parameter	Symbol	Values			Linit	Note / Test condition	
Min. Typ. Max.		Max.	Oilit	Note / Test condition			
Input capacitance <sup>7)</sup>	C <sub>iss</sub>		4500	5400			
Output capacitance 7)	Coss	-	1500	1900	pF	$V_{\rm GS}$ =0 V, $V_{\rm DS}$ =40 V, $f$ =1 MHz	
Reverse transfer capacitance <sup>7)</sup>	C <sub>rss</sub>		37	52			
Turn-on delay time	$t_{\sf d(on)}$		14				
Rise time	$t_{\rm r}$		6.0			$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =25 A, $R_{\rm G,ext}$ =1.6 $\Omega$	
Turn-off delay time	$t_{\sf d(off)}$	]-	22	]-	ns		
Fall time	$t_{f}$		6.5				

<sup>&</sup>lt;sup>7)</sup> Defined by design. Not subject to production test.

## OptiMOS™ 6 Power-Transistor, 80 V ISC018N08NM6SC



Table 6 Gate charge characteristics 8)

Parameter	Cymphol		Values			Note / Test condition	
raiailletei	Symbol	Min.	Тур.	Max.	Onic	Note / Test condition	
Gate to source charge <sup>9)</sup>	$Q_{gs}$		22	26	nC		
Gate charge at threshold <sup>9)</sup>	$Q_{\mathrm{g(th)}}$		13.5	16.2	nC		
Gate to drain charge <sup>9)</sup>	$Q_{\mathrm{gd}}$	]_	12.7	17.8	nC	$V_{DD}$ =40 V, $I_{D}$ =25 A, $V_{GS}$ =0 to 10 V	
Switching charge	$Q_{\rm sw}$		21	-	nC	V <sub>DD</sub> 10 v, v <sub>D</sub> 23 N, v <sub>GS</sub> 0 to 10 v	
Gate charge total <sup>9)</sup>	$Q_{ m g}$		63	76	nC		
Gate plateau voltage	$V_{ m plateau}$		4.8	-	V		
Output charge <sup>9)</sup>	Q <sub>oss</sub>	-	126	158	nC	V <sub>DS</sub> =40 V, V <sub>GS</sub> =0 V	

<sup>8)</sup> See "Gate charge waveforms" for parameter definition

#### Table 7 Reverse diode

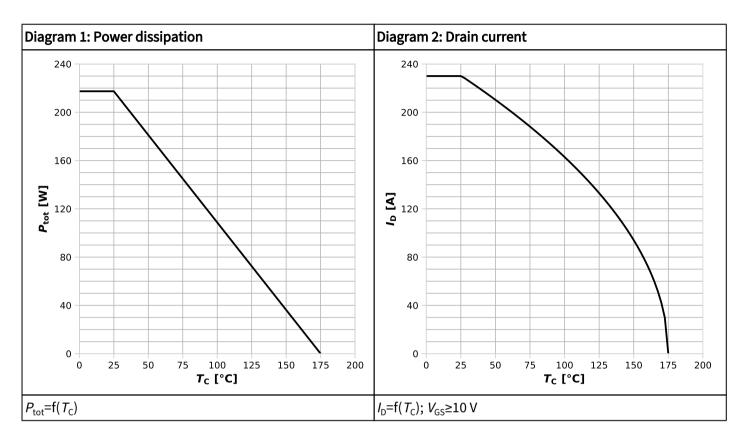
Parameter	Symbol	Values		Linit	Note / Test condition		
Min. Typ. Max.		Unit	Note / Test condition				
Diode continuous forward current	$I_{S}$			197	А	T −25 °C	
Diode pulse current	I <sub>S,pulse</sub>	_	_	920		<i>T</i> <sub>c</sub> =25 °C	
Diode forward voltage	$V_{\rm SD}$	-	0.80	1.0	V	$V_{\rm GS}$ =0 V, $I_{\rm F}$ =50 A, $T_{\rm j}$ =25 °C	
Reverse recovery time <sup>10)</sup>	$t_{rr}$		45	67.5	ns	V-40 V I-25 A di/d⊬100 A/uc	
Reverse recovery charge <sup>10)</sup>	$Q_{\rm rr}$	-	54	81	nC	V <sub>R</sub> =40 V, I <sub>F</sub> =25 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs	
Reverse recovery time <sup>10)</sup>	$t_{rr}$		26	39	ns	V-40 V I-25 A di/d⊬1000 A/us	
Reverse recovery charge <sup>10)</sup>	$Q_{\rm rr}$	]	286	429	nC	$V_{\rm R}$ =40 V, $I_{\rm F}$ =25 A, d $i_{\rm F}$ /d $t$ =1000 A/ $\mu$ s	

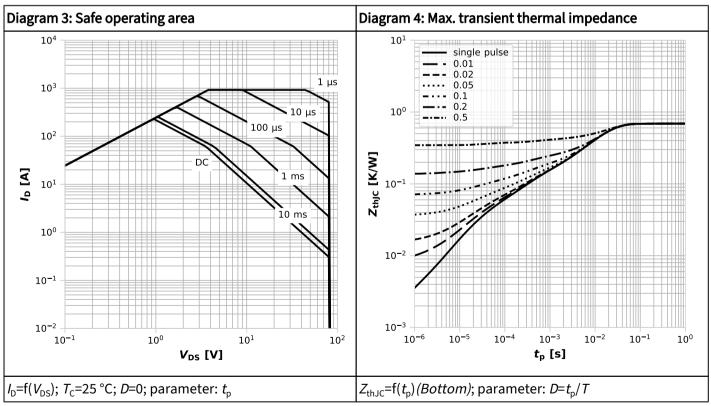
 $<sup>^{10)}</sup>$  Defined by design. Not subject to production test.

<sup>9)</sup> Defined by design. Not subject to production test.

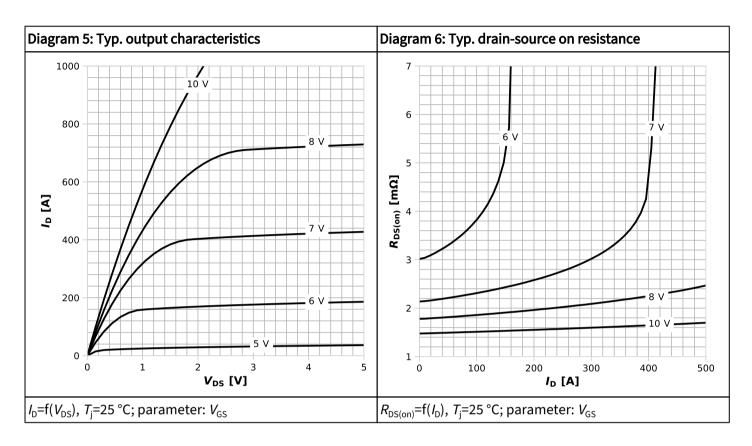


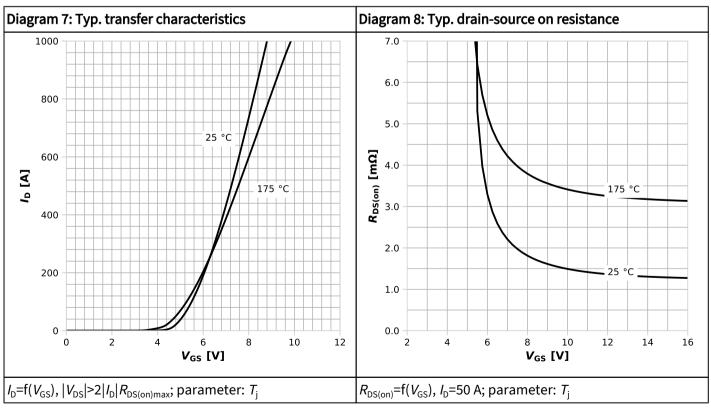
## 4 Electrical characteristics diagrams



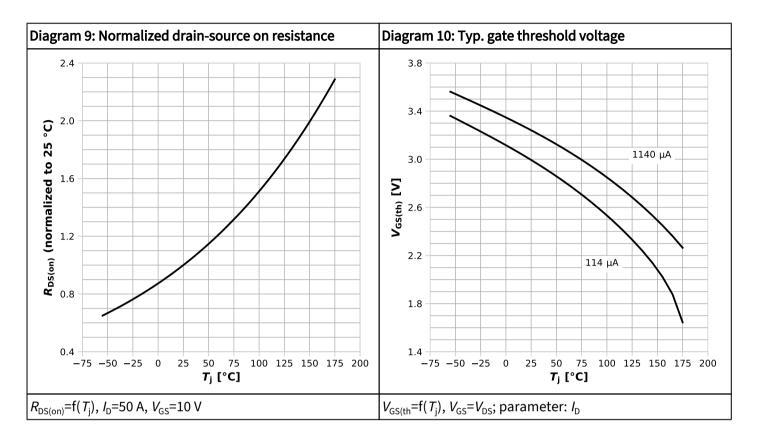


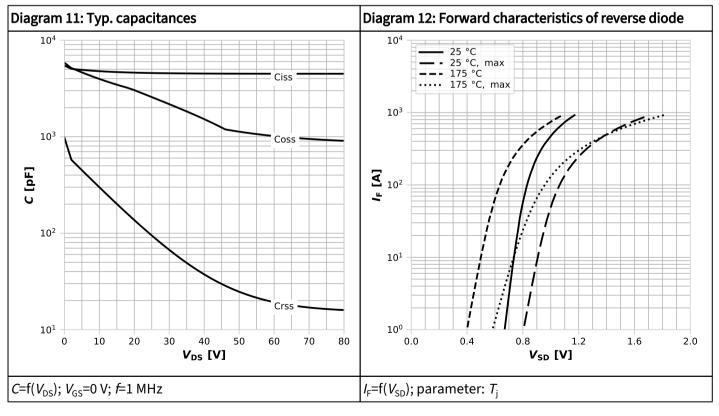




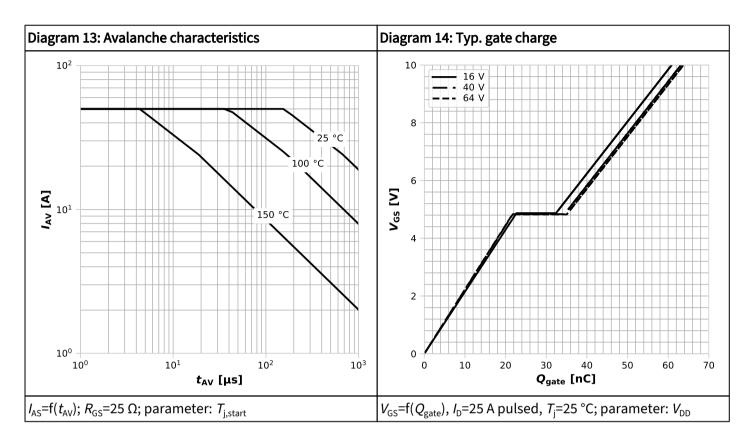


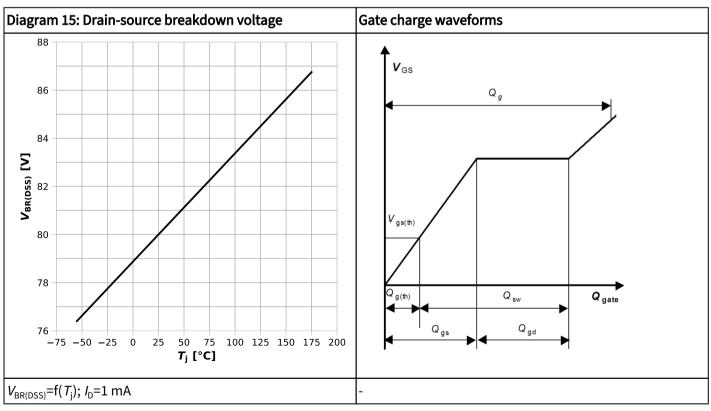






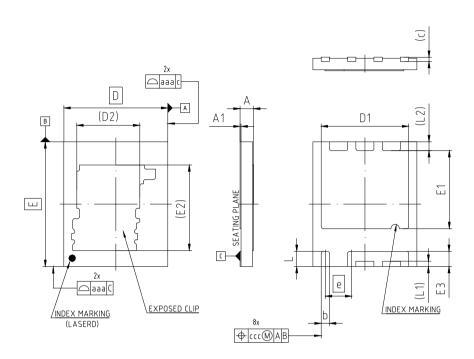








## 5 Package outlines



PACKAGE - GROUP NUMBER:	PG-WSC	ON-8-U01			
DIMENSIONS	MILLIMETERS		DIMENSIONS	MILLIM	ETERS
DIMENSIONS	MIN.	MAX.	DIMENSIONS	MIN.	MAX.
Α	0.55	0.75	е	1.:	27
A1	0.00	0.05	L	0.68	0.78
b	0.35	0.45	L1	0.25	
С	0.	0.20		0.42	
D	5.	00	aaa	0.05	
D1	4.11	4.31	ccc	0.	10
D2	3.	03			
E	6.00				
E1	3.66	3.86			
E2	4.11				
E3	0.63	0.83			

NOTE: DIMENSIONS DO NOT INCLUDE MOLD FLASH, PROTRUSION OR GATE BURRS

Figure 1 Outline PG-WSON-8, dimensions in mm



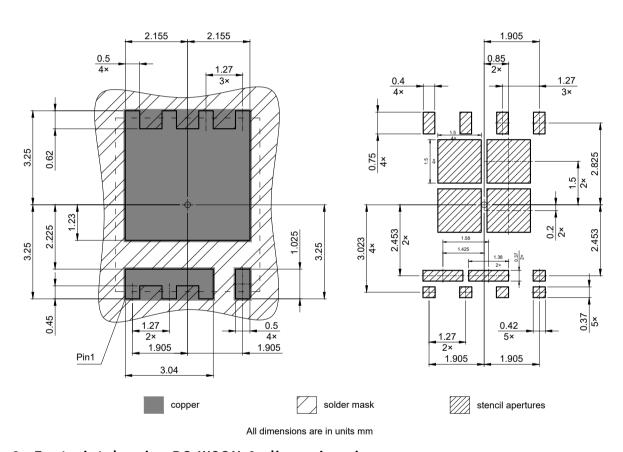
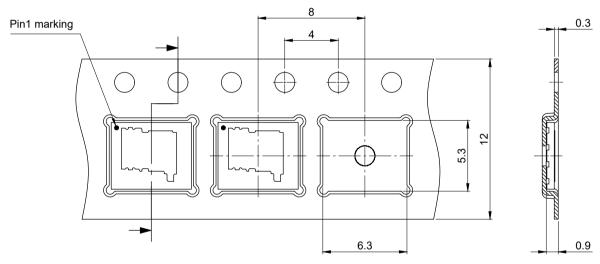


Figure 2 Footprint drawing PG-WSON-8, dimensions in mm





All dimensions are in units mm
The drawing is in compliance with ISO 128-30, Projection Method 1 [← ⊕]

Figure 3 Packaging variant PG-WSON-8, dimensions in mm

### Public

# OptiMOS™ 6 Power-Transistor, 80 V ISC018N08NM6SC



## **Revision history**

ISC018N08NM6SC

### Revision 2025-02-17, Rev. 1.0

**Previous revisions** 

Revision	Date	Subjects (major changes since last revision)
1.0	2025-02-17	Release of final version

#### **Public**

## OptiMOS™ 6 Power-Transistor, 80 V ISC018N08NM6SC



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